

# AN7522

## Dual 3-W BTL audio power amplifier

### ■ Overview

AN7522 is an audio power amplifier IC for the stereo system. In the BTL (balanced transformerless) method, fewer external parts and easier design for applications are required.

### ■ Features

- 3-W output ( $8\ \Omega$ ) with supply voltage of 8 V
- On-chip standby function
- On-chip volume function

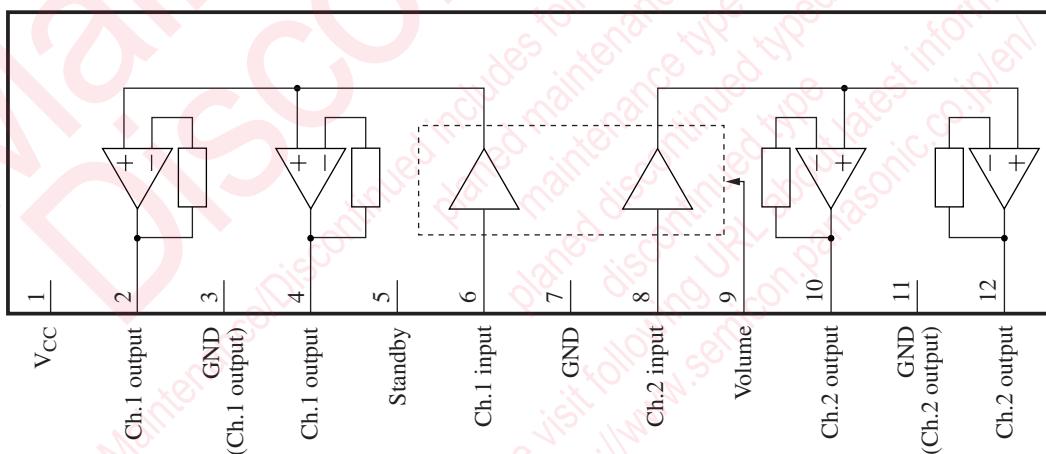
### ■ Applications

- Televisions, audio equipment, personal computers, and active speakers

### ■ Package

- HSIP012-P-0000E

### ■ Block Diagram



### ■ Pin Descriptions

Pin No.	Descriptions	Pin No.	Descriptions
1	Supply voltage	7	Ground (input)
2	Ch.1 + output	8	Ch.2 input
3	Ground (output ch.1)	9	Volume (max. volume if this pin is open.)
4	Ch.1 – output	10	Ch.2 – output
5	Standby (standby state if this pin is open.)	11	Ground (output ch.2)
6	Ch.1 input	12	Ch.2 + output

### ■ Absolute Maximum Ratings

Parameter	Symbol	Rating	Unit
Supply voltage <sup>*2</sup>	V <sub>CC</sub>	14	V
Supply current	I <sub>CC</sub>	2.0	A
Power dissipation <sup>*3</sup>	P <sub>D</sub>	1.92	W
Operating ambient temperature <sup>*1</sup>	T <sub>opr</sub>	-25 to +70	°C
Storage temperature <sup>*1</sup>	T <sub>stg</sub>	-55 to +150	°C

Note) \*1: Except for the operating ambient temperature and storage temperature, all ratings are for T<sub>a</sub> = 25°C.

\*2: At no signal.

\*3: The power dissipation shown is the value for T<sub>a</sub> = 70°C.

### ■ Recommended Operating Range

Parameter	Symbol	Range	Unit
Supply voltage	V <sub>CC</sub>	3.5 to 13.5	V

### ■ Electrical Characteristics at V<sub>CC</sub> = 8.0 V, R<sub>L</sub> = 8 Ω, f = 1 kHz, T<sub>a</sub> = 25°C ± 2°C

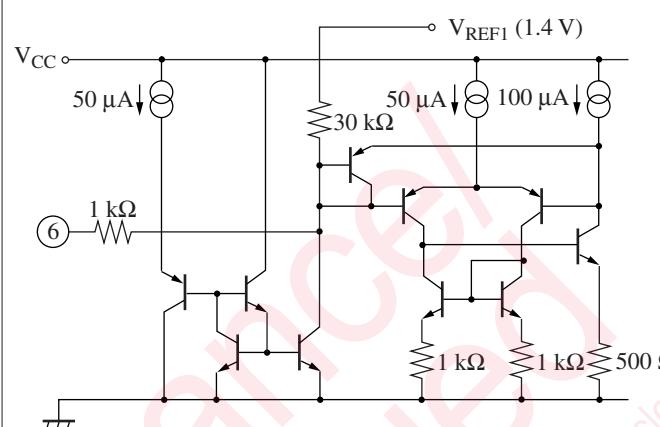
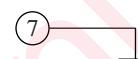
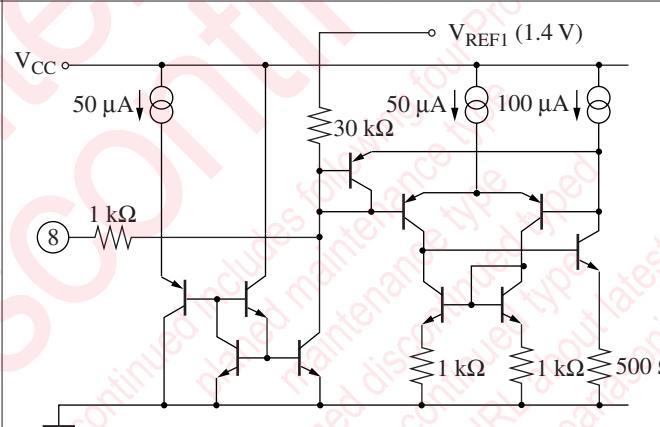
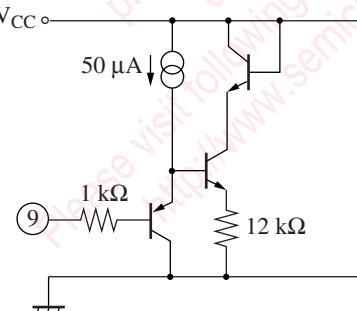
Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Quiescent circuit current	I <sub>CQ</sub>	V <sub>IN</sub> = 0 mV, Vol. = 0 V	—	45	100	mA
Standby current	I <sub>STB</sub>	V <sub>IN</sub> = 0 mV, Vol. = 0 V	—	1	10	μA
Output noise voltage *	V <sub>NO</sub>	R <sub>g</sub> = 10 kΩ, Vol. = 0 V	—	0.10	0.4	mV[rms]
Voltage gain	G <sub>V</sub>	P <sub>O</sub> = 0.5 W, Vol. = 1.25 V	31	33	35	dB
Total harmonic distortion	THD	P <sub>O</sub> = 0.5 W, Vol. = 1.25 V	—	0.10	0.5	%
Maximum output power	P <sub>O1</sub>	THD = 10%, Vol. = 1.25 V	2.4	3.0	—	W
Ripple rejection ratio *	RR	R <sub>g</sub> = 10 kΩ, Vol. = 0 V, V <sub>R</sub> = 1 V[rms], f <sub>R</sub> = 120 Hz	30	50	—	dB
Output offset voltage	V <sub>OFF</sub>	R <sub>g</sub> = 10 kΩ, Vol. = 0 V	-250	0	250	mV
Volume attenuation rate *	Att	P <sub>O</sub> = 0.5 W, Vol. = 0 V	70	85	—	dB
Channel balance 1	CB1	P <sub>O</sub> = 0.5 W, Vol. = 1.25 V	-1	0	1	dB
Channel balance 2	CB2	P <sub>O</sub> = 0.5 W, Vol. = 0.6 V	-3	0	3	dB
Intermediate voltage gain	G <sub>VM</sub>	P <sub>O</sub> = 0.5 W, Vol. = 0.6 V	20.5	23.5	26.5	dB
Channel crosstalk	CT	P <sub>O</sub> = 0.5 W, Vol. = 1.25 V	40	55	—	dB

Note) \*: In measuring, the filter for the range of 15 Hz to 30 kHz (12 dB/OCT) is used.

■ Terminal Equivalent Circuits at  $V_{CC} = 8 \text{ V}$ 

Pin No.	Pin name	Equivalent circuit	Voltage
1	$V_{CC}$	—	8 V
2	Ch.1 + output pin		3.6 V (at no signal)
3	GND		0 V
4	Ch.1 – output pin		3.6 V (at no signal)
5	Standby pin		0 V or 5 V (Standby off at supply 5 V. Standby at 0.4 V less or open.)

■ Terminal Equivalent Circuits at  $V_{CC} = 8 \text{ V}$  (continued)

Pin No.	Pin name	Equivalent circuit	Voltage
6	Ch.1 input pin		1.4 V (Input circuit bias voltage is output.)
7	GND		0 V
8	Ch.2 input pin		1.4 V (Input circuit bias voltage is output.)
9	Volume pin		Supply to 0 V to 1.25 V

■ Terminal Equivalent Circuits at  $V_{CC} = 8\text{ V}$  (continued)

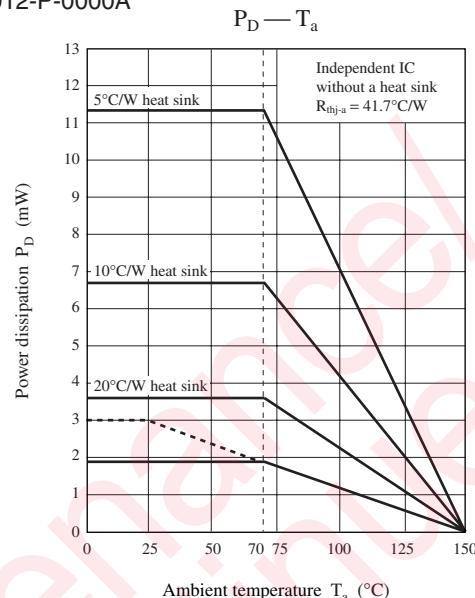
Pin No.	Pin name	Equivalent circuit	Voltage
10	Ch.2 – output pin		3.6 V (at no signal)
11	GND		0 V
12	Ch.2 + output pin		3.6 V (at no signal)

## ■ Usage Notes

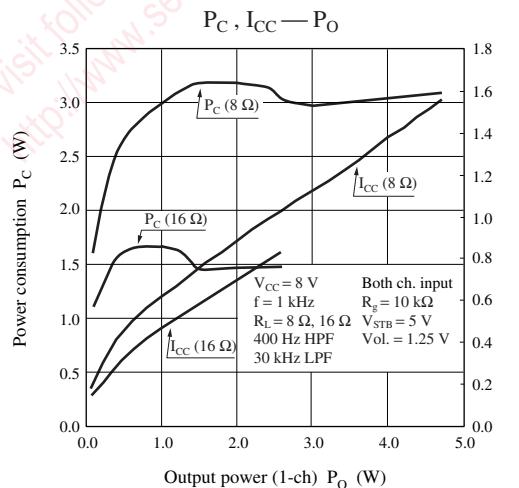
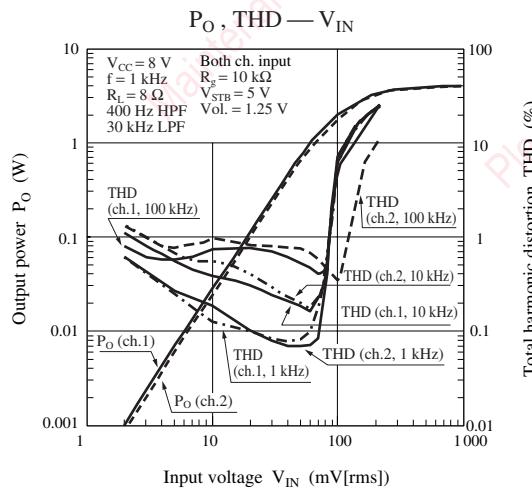
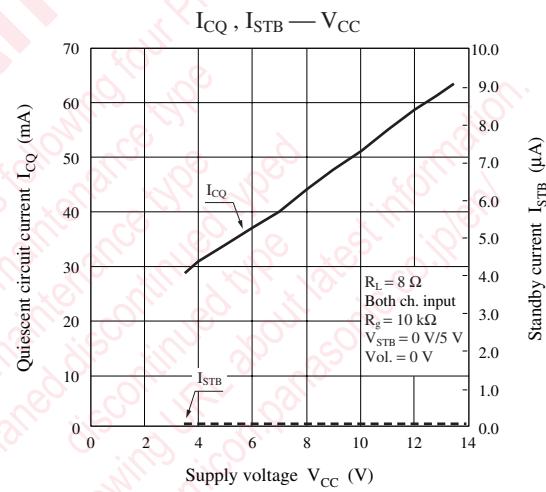
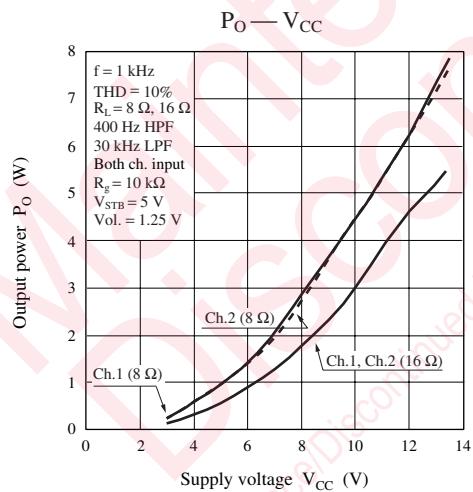
- Please avoid the short-circuits to  $V_{CC}$ , ground, or load short-circuit.
- Please connect the cooling fin with the GND potential.
- The thermal shutdown circuit operates at about  $T_j = 150^\circ\text{C}$ . However, the thermal shutdown circuit is reset automatically if the temperature drops.
- Please carefully design the heat radiation especially when you take out high power at high  $V_{CC}$ .
- Please connect only the ground of signal with the signal GND of the amplifier in the previous stage.

## ■ Technical Data

- $P_D - T_a$  curves of HSIP012-P-0000A

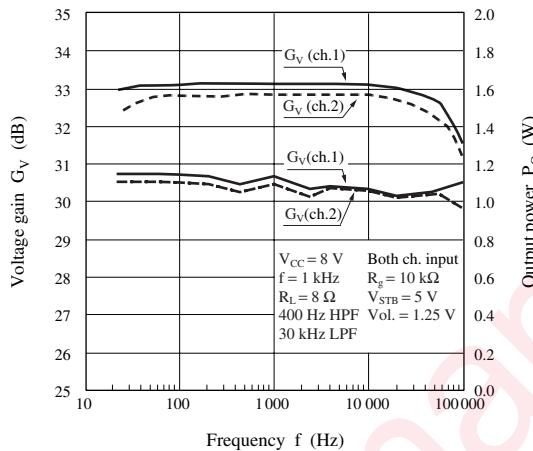


- Main characteristics

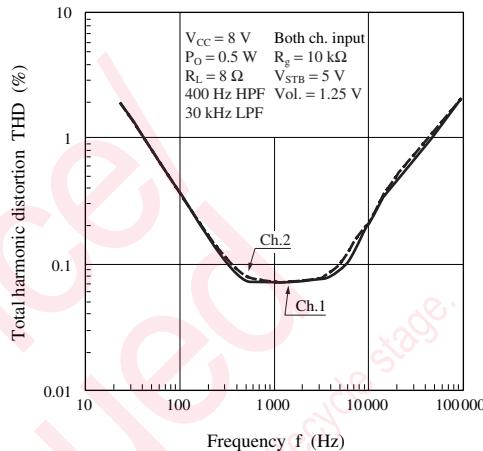
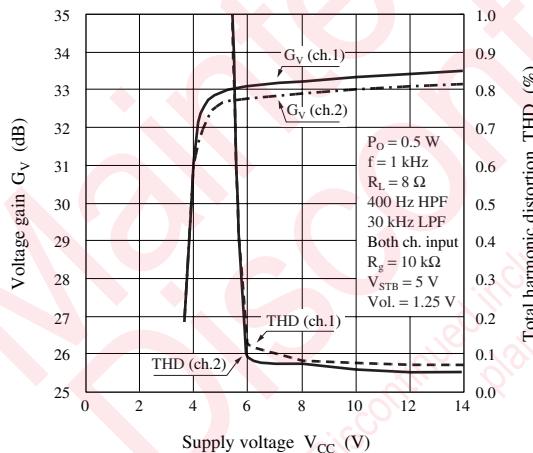
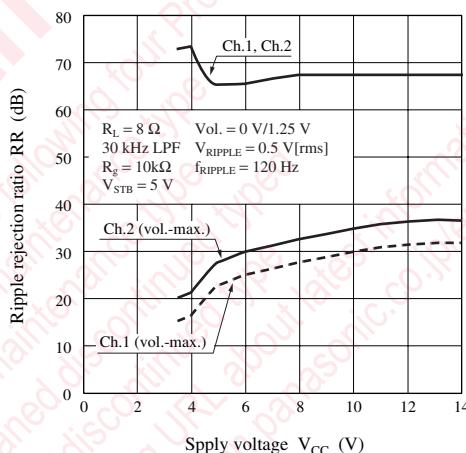
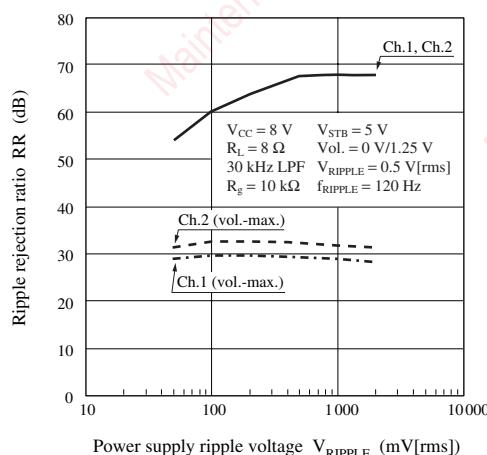
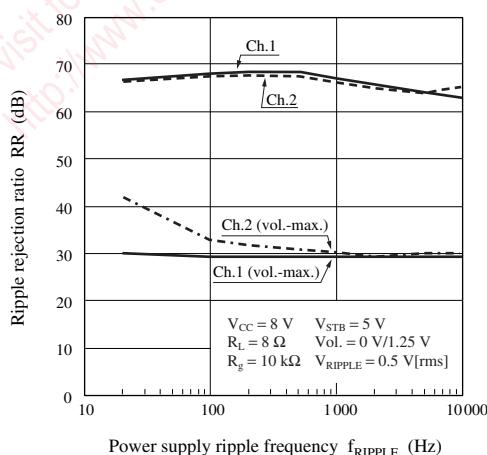


## ■ Technical Data (continued)

- Main characteristics (continued)

 $G_V, P_O$  — f

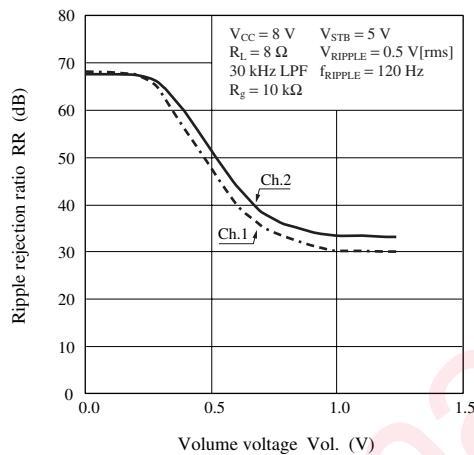
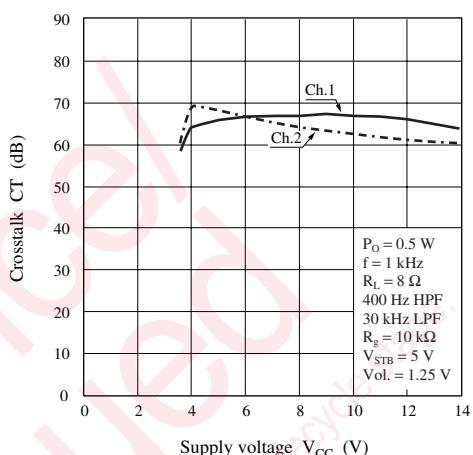
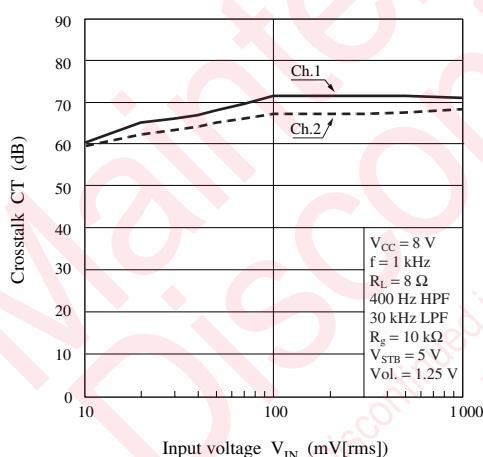
THD — f

 $G_V, \text{THD} — V_{CC}$ RR —  $V_{CC}$ RR —  $V_{RIPPLE}$ RR —  $f_{RIPPLE}$ 

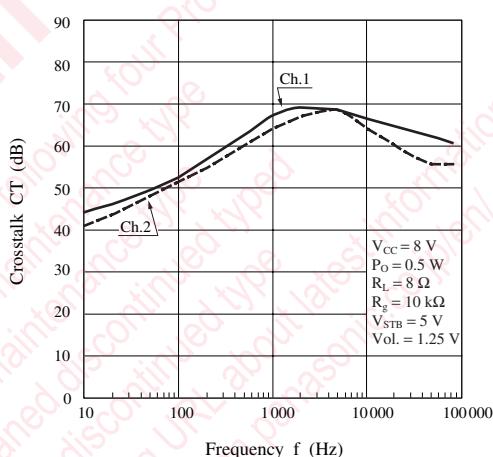
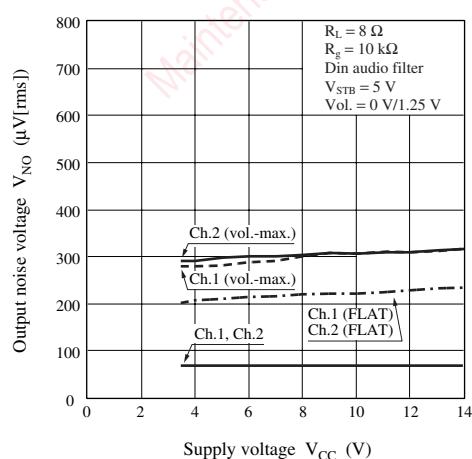
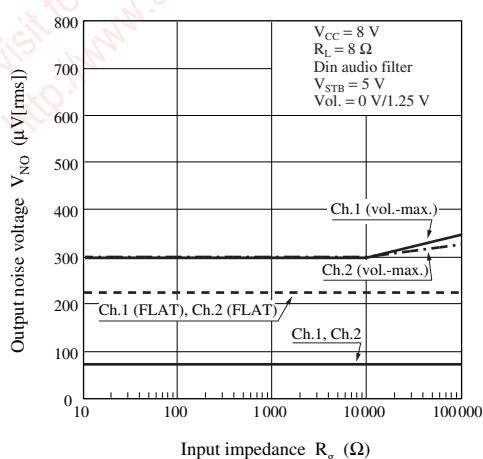
## ■ Technical Data (continued)

- Main characteristics (continued)

RR — Vol.

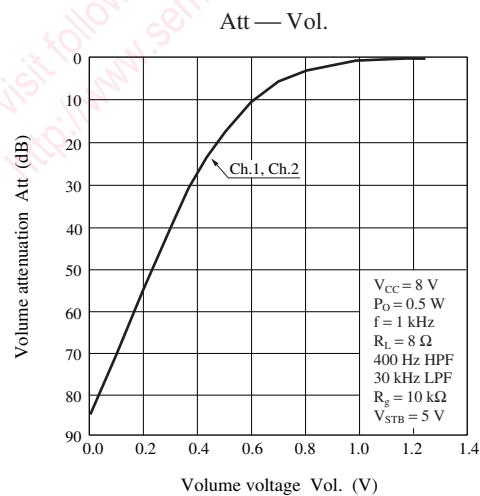
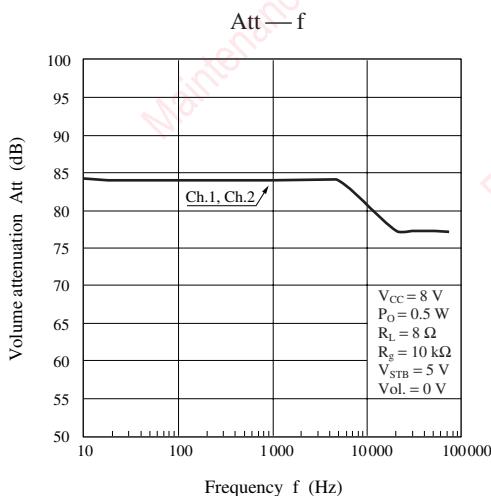
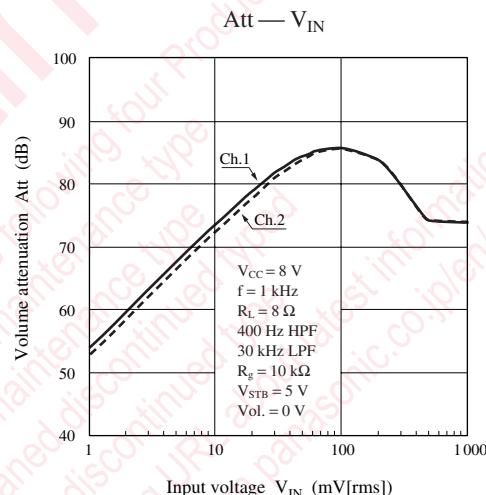
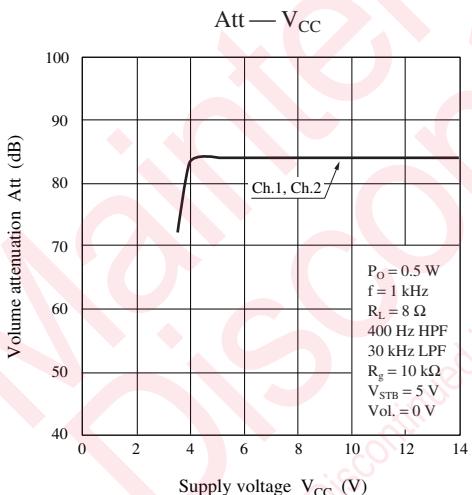
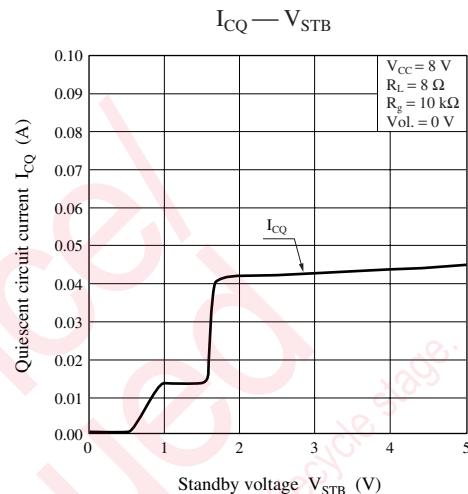
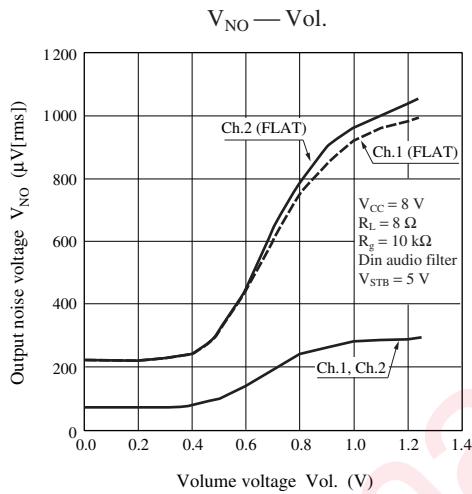
CT — V<sub>CC</sub>CT — V<sub>IN</sub>

CT — f

V<sub>NO</sub> — V<sub>CC</sub>V<sub>NO</sub> — R<sub>g</sub>

## ■ Technical Data (continued)

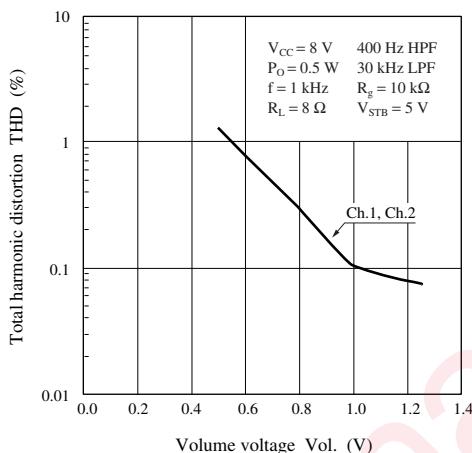
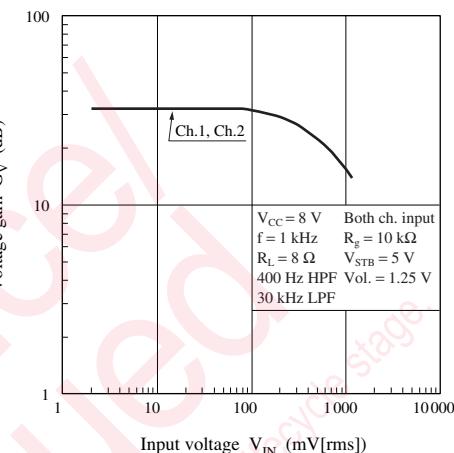
- Main characteristics (continued)



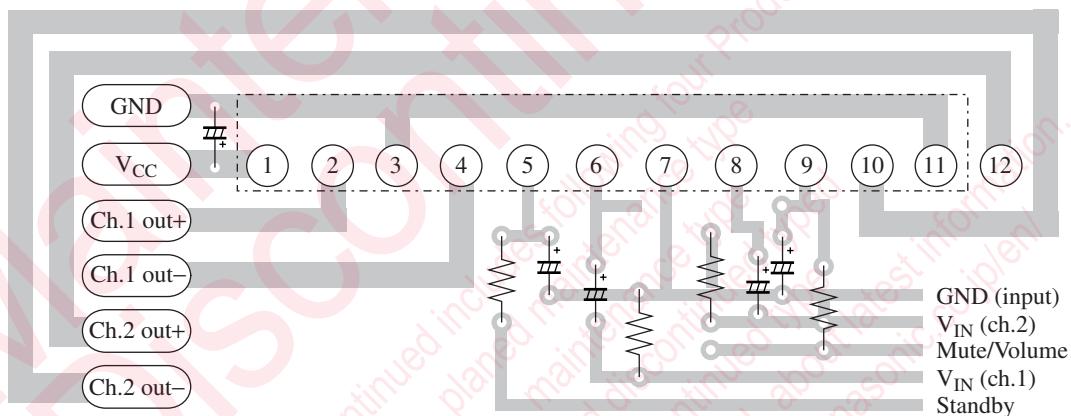
## ■ Technical Data (continued)

- Main characteristics (continued)

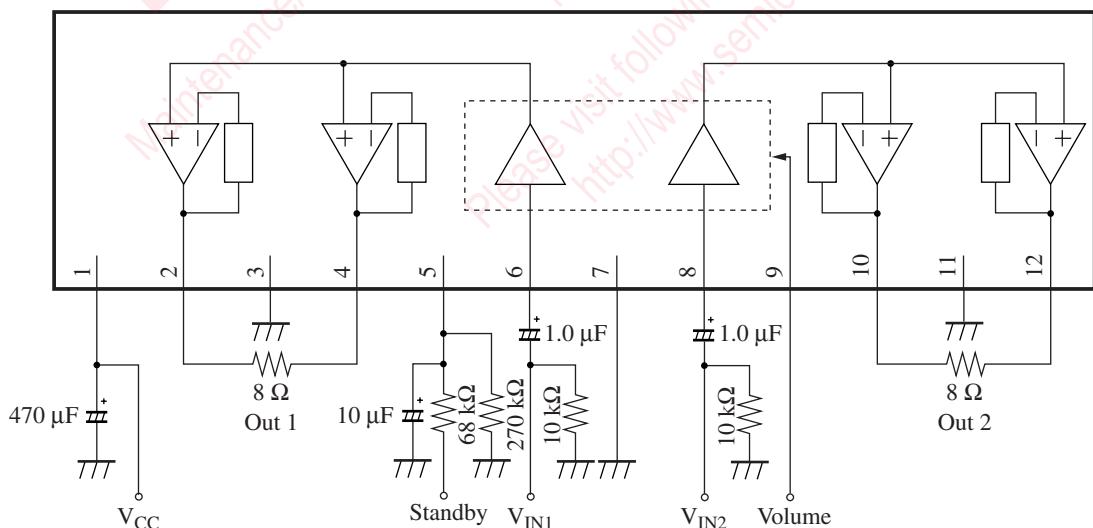
THD — Vol.

 $G_V — V_{IN}$ 

- Example of PCB pattern



## ■ Application Circuit Example



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